

30V N-Channel Trench MOSFET(Preliminary)

Features	Product Summary				
Trench Power Technology		VDS	30V		
• Low R _{DS(ON)}		R _{DS(ON)} (at V _{GS}	_S =10V) < 2.2mΩ		
 Low Gate Charge Optimized for Fast-switching Application 	ins	$R_{DS(ON)}$ (at V_GS	_S =4.5V) < 3.0mΩ		
		I _D (at V _{GS} =10\	√) 160A		
Applications		100% UIS Tested			
 Synchronous Rectification in DC/DC a Isolated DC/DC Converters in Telecon 					
DFN5x6	D S S S S		G		
Device	Packag	je	Marking		
TTG160N03GT	DFN5x6 160N03GT				

Absolute Maximum Ratings $T_c = 25^{\circ}C$, unless otherwise noted						
Parameter		Symbol	Value	Unit		
Drain-Source Voltage (V _{GS} = 0V)		V _{DSS}	30	V		
Continuous Drain Current ^B	T _C = 25°C		51			
	T _C = 100°C		51			
Pulsed Drain Current ^A		I _{DM}	480	Α		
Gate-Source Voltage		V _{GSS}	±20	V		
Single Pulse Avalanche Energy L =0.3mH ^A		E _{AS}	277	mJ		
Avalanche Current ^A		I _{As}	43	Α		
Devuer Dissignation C	T _C = 25°C	P _D	143	W		
Power Dissipation ^C	T _C = 100°C	P _D	71	W		
Operating Junction and Storage Temperature Range		T _J , T _{SGT}	-55~+175	°C		

Thermal Resistance					
Parameter	Symbol	Value	Unit		
Thermal Resistance, Junction-to-Case	R _{thJC}	1.1			
Thermal Resistance, Junction-to-Ambient	R _{thJA}	100	°C/W		



Specifications T _J = 25°C, u	unless othe	rwise noted				
Perometer	Ormhal		Value			
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	•	•				
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0V, I_{D} = 250 \mu A$	30			V
		$V_{DS} = 30V, V_{GS} = 0V, T_{J} = 25^{\circ}C$	= 30V, V _{GS} = 0V, T _J = 25°C		1	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 30V, V_{GS} = 0V, T_{J} = 100^{\circ}C$			25	μA
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 20V$			±100	nA
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1	1.7	2.4	V
Drain Course On Desistance	P	V _{GS} = 10V, I _D = 20A		1.7 2.2		mΩ
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} = 4.5V, I _D = 20A		2.3	3.0	mΩ
Forward Transconductance	9 _{fs}	V _{DS} = 10V, I _D = 20A	34			S
Dynamic	-	•				
Input Capacitance	C _{iss}	- V _{GS} = 0V,		8313		pF
Output Capacitance	C _{oss}	$V_{DS} = 15V,$		951		
Reverse Transfer Capacitance	C _{rss}	f = 1.0MHz		897		
Total Gate Charge	Qg			160		
Gate-Source Charge	Q _{gs}	$V_{DD} = 15V, I_D = 50A, V_{GS} = 10V$		18		nC
Gate-Drain Charge	Q _{gd}			34		
Turn-on Delay Time	t _{d(on)}			27		
Turn-on Rise Time	t _r	V _{DD} = 15V, I _D = 50A,		25		ns
Turn-off Delay Time	t _{d(off)}	$R_{G} = 3\Omega$		90		
Turn-off Fall Time	t _f			40		
Drain-Source Body Diode Characte	ristics	•				
Continuous Body Diode Current ^B	۱ _S	T 0500			51	^
Pulsed Diode Forward Current ^B	I _{SM}	T _C = 25°C			51	A
Body Diode Voltage	V _{SD}	$T_J = 25^{\circ}C, I_{SD} = 30A, V_{GS} = 0V$			1.2	V
Reverse Recovery Time	t _{rr}	I _F = 30A,		43		ns
Reverse Recovery Charge	Q _{rr}	di _F /dt = 100A/µs		40		nC

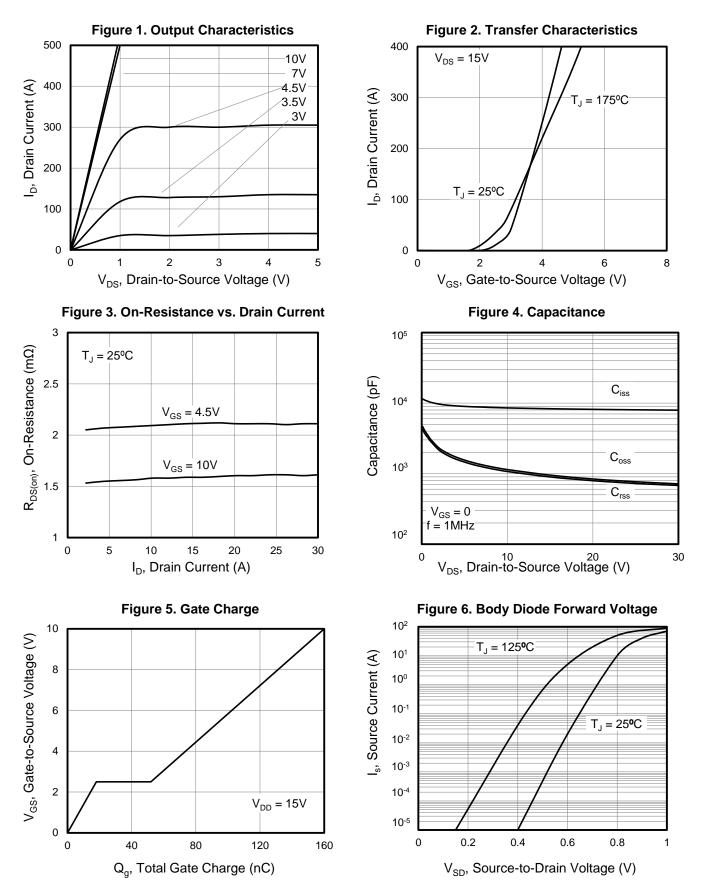
A. Single pulse width limited by maximum junction temperature.

B. The maximum current rating is package limited.

C. The power dissipation P_D is based on $T_{J(MAX)} = 175^{\circ}$ C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

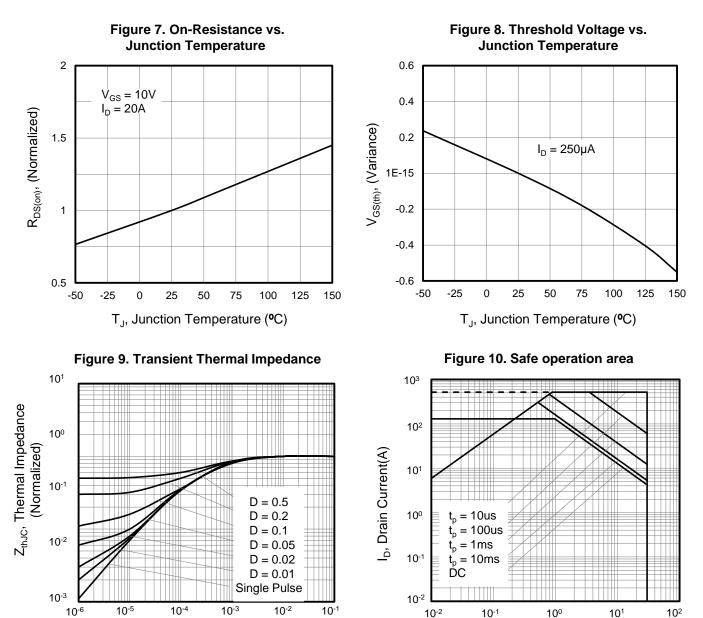


Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted



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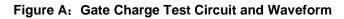
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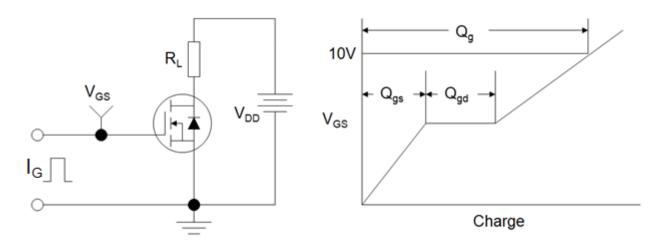


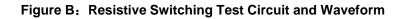
Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted

T_p, Pulse Width (s)

V_{DS}, Drain-Source Voltage(V)







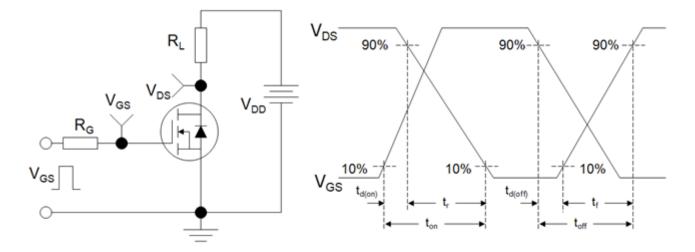
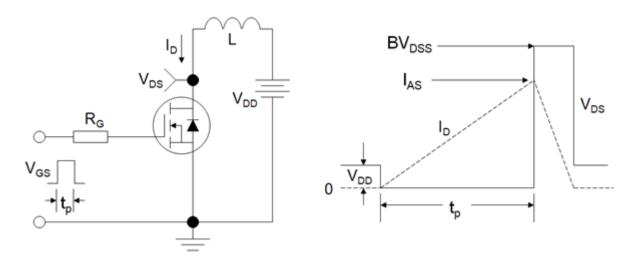
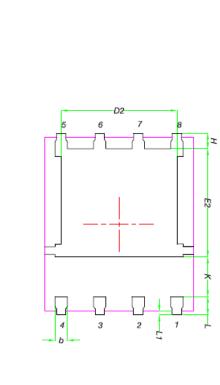
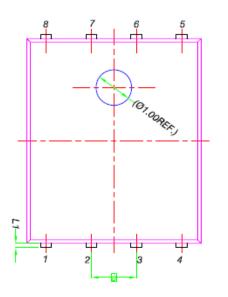


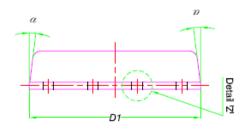
Figure C: Unclamped Inductive Switching Test Circuit and Waveform











		1ILLIMET			MILLIMETERS			
DIM.	MIN.	NOM.	MAX.	DIM.	MIN.	NOM.	MAX.	
А	0.90	1.00	1.10	E	5.90	6.00	6.10	
A1	0	-	0.05	E1	5.70	5.75	5.80	
b	0.33	0.41	0.51	E2	3.38	3.58	3.78	
С	0.20	0.25	0.30	е	1.27 BSC			
D1	4.80	4.90	5.00	Н	0.41 0.51 0.6		0.61	
D2	3.61	3.81	3.96	К	1.10	-	-	
			•	L	0.51	0.61	0.71	
				L1	0.06	0.13	0.20	
				α	0°	-	12°	

DFN5x6



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